



JMSL0606AGD

60V 6.4mΩ N-Ch Power MOSFET

Features

- Ultra-low $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested, 100% R_g Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant

Product Summary

| Parameter | Typ. | Unit |
|--|------|------|
| V_{DS} | 60 | V |
| $V_{GS(th)}$ | 1.8 | V |
| I_D (@ $V_{GS} = 10V$) ⁽¹⁾ | 55 | A |
| $R_{DS(ON)}$ (@ $V_{GS} = 10V$) | 6.4 | mΩ |
| $R_{DS(ON)}$ (@ $V_{GS} = 4.5V$) | 7.6 | mΩ |

Applications

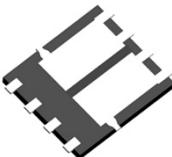
- Power Management in Telecom., Industrial Automation, CE
- Motor Driving in Power Tool, E-vehicle, Robotics
- Current Switching in DC/DC & AC/DC (SR) Sub-systems

PDFN5x6-8L-D

Top View

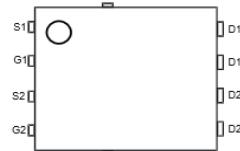


Bottom View

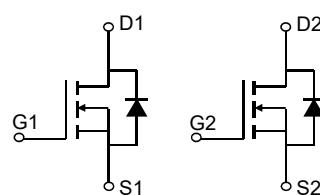


Pin Configuration

Top View



Chip-1 & Chip-2

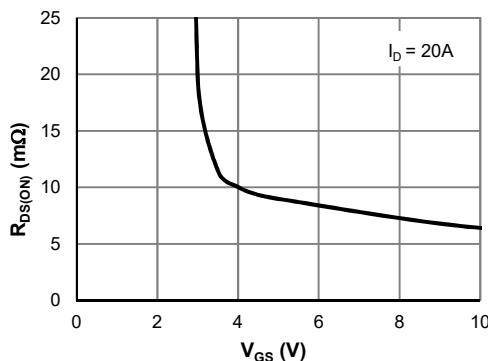


Ordering Information

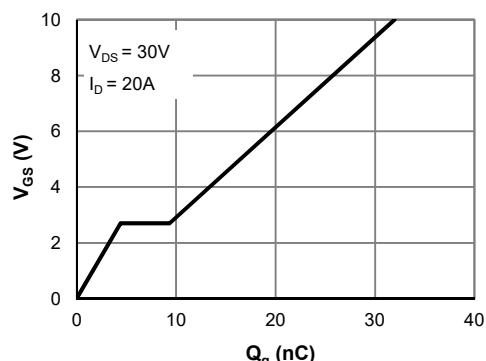
| Device | Package | # of Pins | Marking | MSL | T_J (°C) | Media | Quantity (pcs) |
|----------------|--------------|-----------|---------|-----|------------|--------------|----------------|
| JMSL0606AGD-13 | PDFN5x6-8L-D | 8 | L0606AD | 1 | -55 to 150 | 13-inch Reel | 5000 |

Absolute Maximum Ratings (@ $T_A = 25^\circ C$ unless otherwise specified)

| Parameter | Symbol | Value | Unit |
|---|----------------|------------|------|
| Drain-to-Source Voltage | V_{DS} | 60 | V |
| Gate-to-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current ⁽¹⁾ | I_D | 55 | A |
| $T_C = 100^\circ C$ | | 35 | |
| Pulsed Drain Current ⁽²⁾ | I_{DM} | 200 | A |
| Avalanche Current ⁽³⁾ | I_{AS} | 39 | A |
| Avalanche Energy ⁽³⁾ | E_{AS} | 76 | mJ |
| Power Dissipation ⁽⁴⁾ | P_D | 39 | W |
| $T_C = 100^\circ C$ | | 16 | |
| Junction & Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |

 $R_{DS(ON)}$ vs. V_{GS} 

Gate Charge



Electrical Characteristics (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|---|-----------------------------|---|------|------------|------------|------------------|
| STATIC PARAMETERS | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$ | 60 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 48\text{V}, V_{GS} = 0\text{V}$ $T_J = 55^\circ\text{C}$ | | | 1.0 5.0 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$ | | | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(\text{th})}$ | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ | 1.2 | 1.8 | 2.5 | V |
| Static Drain-Source ON-Resistance | $R_{DS(\text{ON})}$ | $V_{GS} = 10\text{V}, I_D = 20\text{A}$ $V_{GS} = 4.5\text{V}, I_D = 15\text{A}$ | | 6.4 7.6 | 7.8 9.7 | $\text{m}\Omega$ |
| Forward Transconductance | g_{FS} | $V_{DS} = 5\text{V}, I_D = 20\text{A}$ | | 121 | | S |
| Diode Forward Voltage | V_{SD} | $I_S = 1\text{A}, V_{GS} = 0\text{V}$ | | 0.68 | 1.0 | V |
| Diode Continuous Current | I_S | $T_C = 25^\circ\text{C}$ | | | 39 | A |
| DYNAMIC PARAMETERS⁽⁵⁾ | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0\text{V}, V_{DS} = 30\text{V}, f = 1\text{MHz}$ | | 2030 | | pF |
| Output Capacitance | C_{oss} | | | 445 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 4.4 | | pF |
| Gate Resistance | R_g | $V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$ | | 1.8 | | Ω |
| SWITCHING PARAMETERS⁽⁵⁾ | | | | | | |
| Total Gate Charge (@ $V_{GS} = 10\text{V}$) | Q_g | $V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 30\text{V}, I_D = 20\text{A}$ | | 32 | | nC |
| Total Gate Charge (@ $V_{GS} = 4.5\text{V}$) | Q_g | | | 14.9 | | nC |
| Gate Source Charge | Q_{gs} | | | 4.4 | | nC |
| Gate Drain Charge | Q_{gd} | | | 4.9 | | nC |
| Turn-On DelayTime | $t_{D(\text{on})}$ | $V_{GS} = 10\text{V}, V_{DS} = 30\text{V}$ $R_L = 1.5\Omega, R_{\text{GEN}} = 6\Omega$ | | 6.3 | | ns |
| Turn-On Rise Time | t_r | | | 7.8 | | ns |
| Turn-Off DelayTime | $t_{D(\text{off})}$ | | | 39 | | ns |
| Turn-Off Fall Time | t_f | | | 15.5 | | ns |
| Body Diode Reverse Recovery Time | t_{rr} | | | 39 | | ns |
| Body Diode Reverse Recovery Charge | Q_{rr} | $I_F = 20\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | | 45 | | nC |

Thermal Performance

| Parameter | Symbol | Typ. | Max. | Unit |
|---|-----------------|------|------|--------------------|
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 50 | 65 | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 2.5 | 3.2 | $^\circ\text{C/W}$ |

Notes:

1. Computed continuous current assumes the condition of $T_{J_{\text{Max}}}$ while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under $T_{J_{\text{Max}}} = 150^\circ\text{C}$.
3. This single-pulse measurement was taken under the following condition [$L = 100\mu\text{H}, V_{GS} = 10\text{V}, V_{DD} = 30\text{V}$] while its value is limited by $T_{J_{\text{Max}}} = 150^\circ\text{C}$.
4. The power dissipation P_D is based on $T_{J_{\text{Max}}} = 150^\circ\text{C}$.
5. This value is guaranteed by design hence it is not included in the production test.

Typical Electrical & Thermal Characteristics

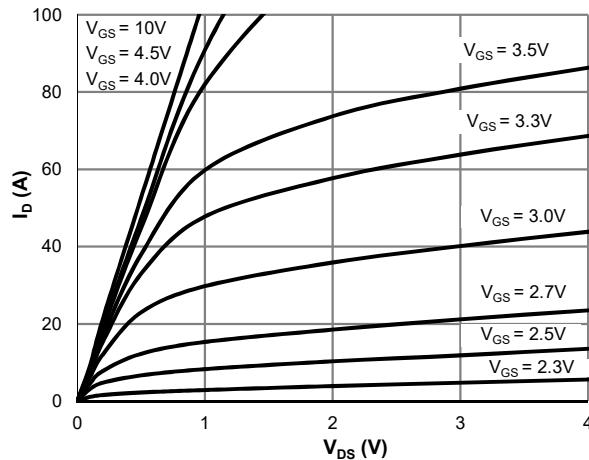


Figure 1: Saturation Characteristics

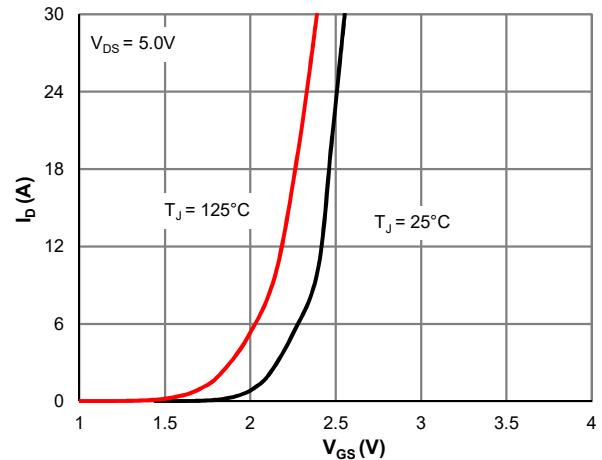


Figure 2: Transfer Characteristics

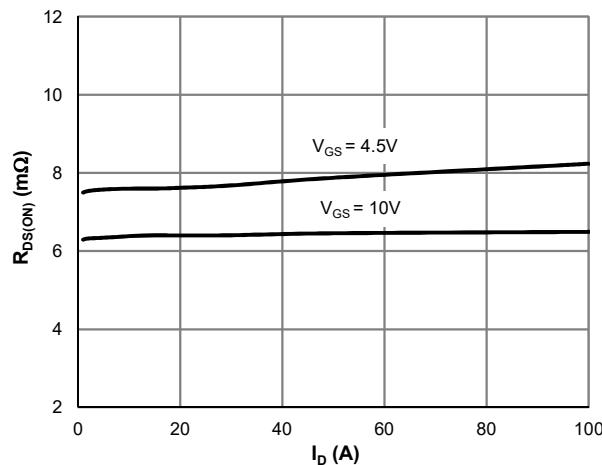


Figure 3: $R_{DS(ON)}$ vs. Drain Current

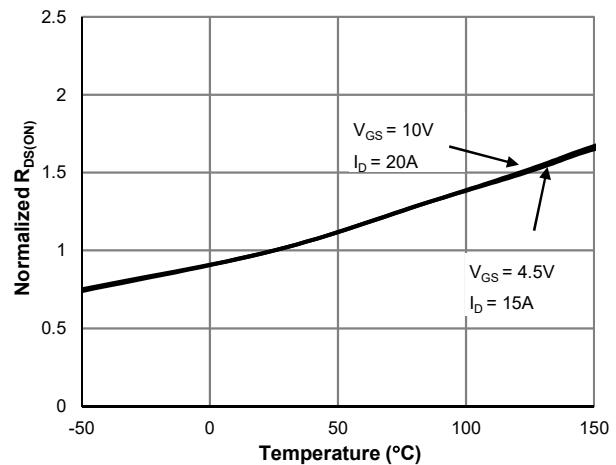


Figure 4: $R_{DS(ON)}$ vs. Junction Temperature

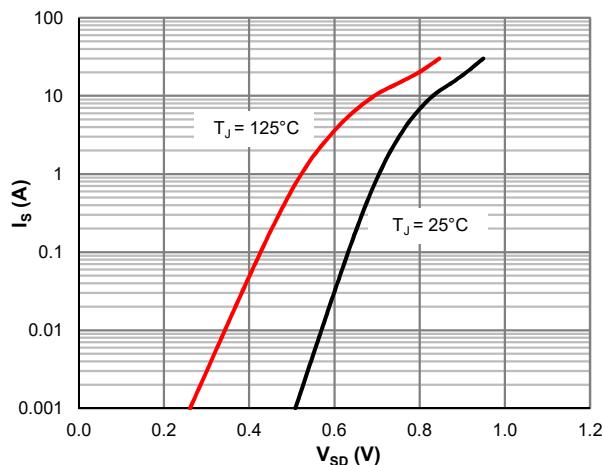


Figure 5: Body-Diode Characteristics

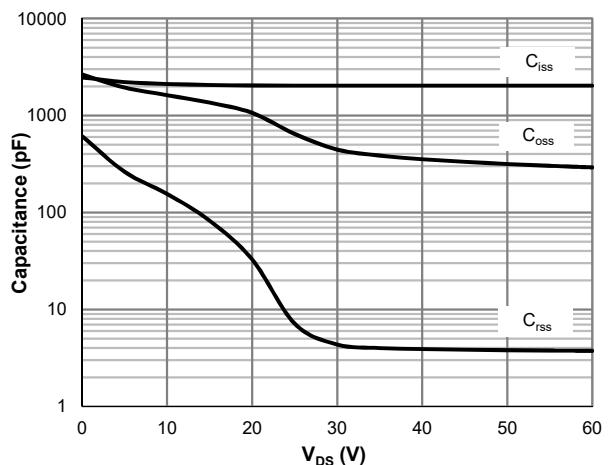


Figure 6: Capacitance Characteristics

Typical Electrical & Thermal Characteristics

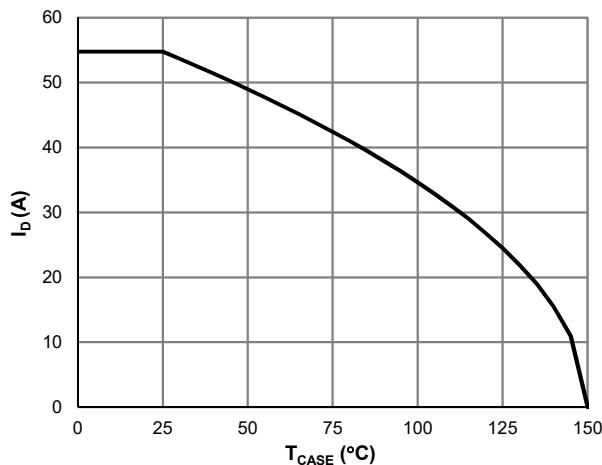


Figure 7: Current De-rating

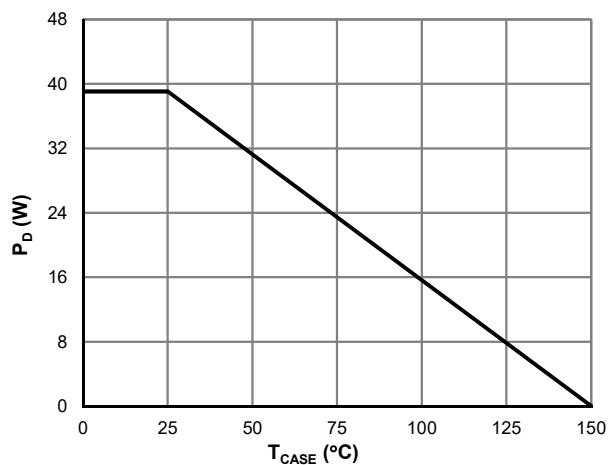


Figure 8: Power De-rating

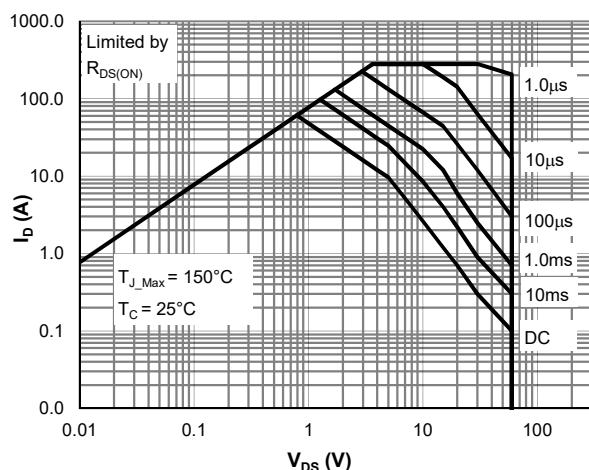


Figure 9: Maximum Safe Operating Area

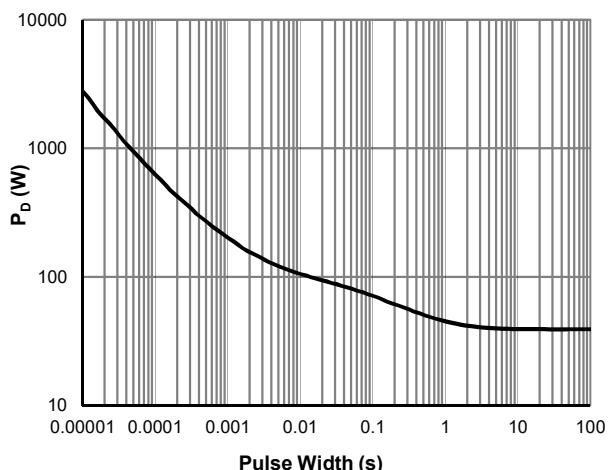


Figure 10: Single Pulse Power Rating, Junction-to-Case

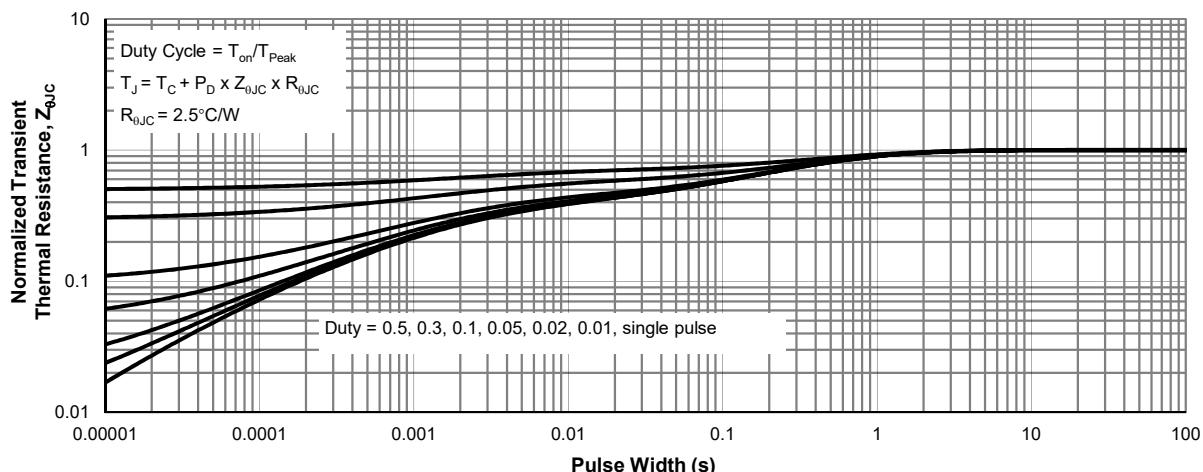
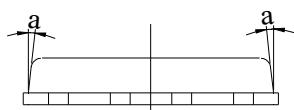
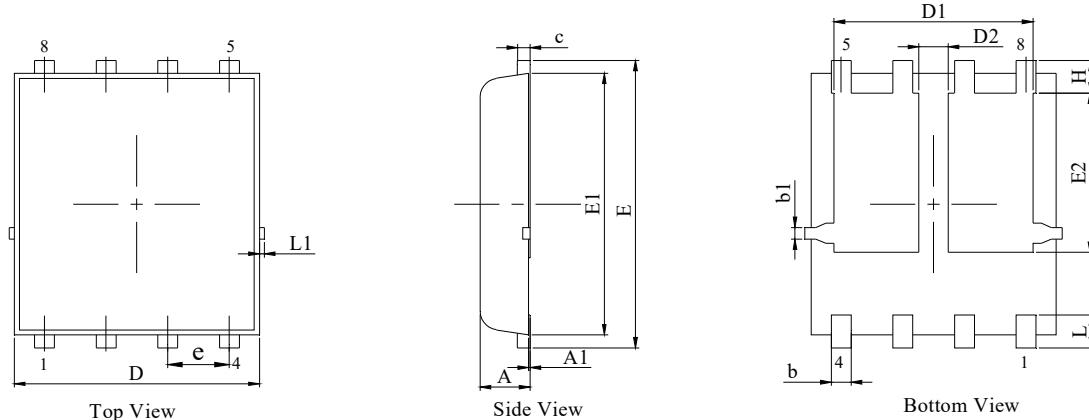
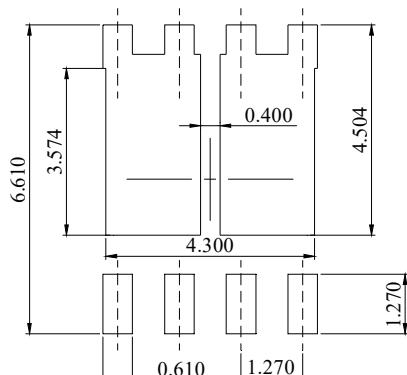


Figure 11: Normalized Maximum Transient Thermal Impedance

PDFN5x6-8L-D Package Information
Package Outline

Front View
NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
2. ALL DIMNESIONS IN MILLIMETER (ANGLE IN DEGREE).
3. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS.

| DIM. | MILLIMETER | | |
|------|------------|------|-------|
| | MIN. | NOM. | MAX. |
| A | 0.90 | 1.00 | 1.10 |
| A1 | 0.00 | - | 0.10 |
| b | 0.31 | 0.41 | 0.51 |
| b1 | 0.15 | 0.25 | 0.35 |
| c | 0.23 | - | 0.33 |
| D | 4.95 | 5.05 | 5.15 |
| D1 | 4.00 | 4.10 | 4.20 |
| D2 | 0.50 | 0.60 | 0.70 |
| E | 6.05 | 6.15 | 6.25 |
| E1 | 5.50 | 5.60 | 5.70 |
| E2 | 3.31 | 3.41 | 3.51 |
| e | 1.27BSC | | |
| H | 0.60 | 0.70 | 0.80 |
| L | 0.50 | 0.70 | 0.80 |
| L1 | - | - | 0.125 |
| a | - | - | 12° |

Recommended Soldering Footprint


DIMENSIONS:MILLIMETERS